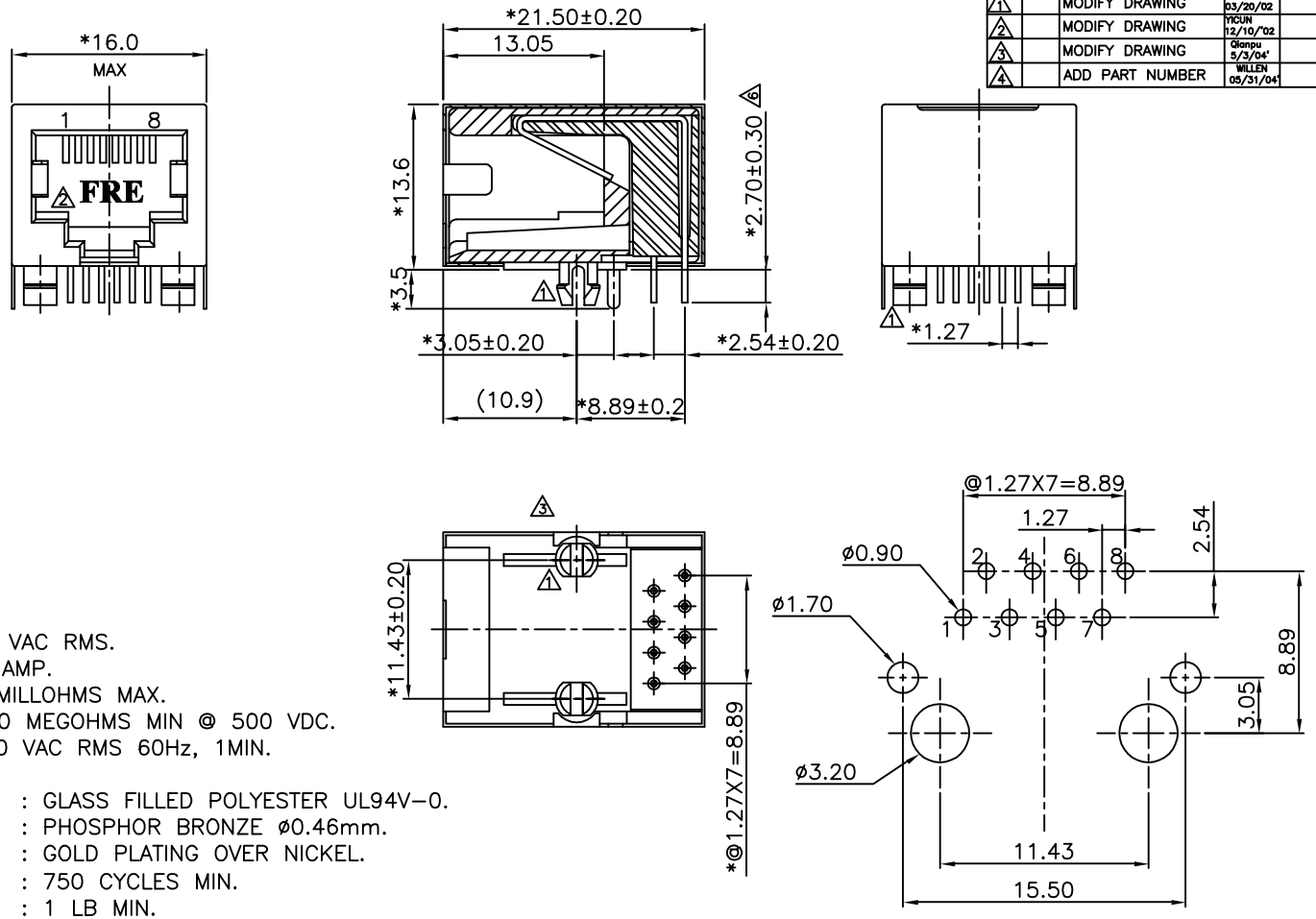
D1RFRD006

REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD
1		MODIFY DRAWING	SAMMY 03/20/02	
2		MODIFY DRAWING	YICUN 12/10/'02	
3		MODIFY DRAWING	Qianpu 5/3/04'	
4		ADD PART NUMBER	WILLEN 05/31/04'	
5		ADD PART NUMBER	QIANPU 6/24/04'	
6		MODIFY DRAWING	QIANPU 7/9/04'	



PC Board Layout Component Side Shown

NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 40 MILLOHMS MAX.
4. INSULATION RESISTANCE : 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE ø0.46mm.
3. PLATING : GOLD PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER : 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
2. OPERATION: 0°C TO 70°C.

MATES WITH MODULAR PLUG CONFORMING TO FCC PART 68, SUBPART F.

CUL FILE NO. E163191

PART NUMBER: E5988-1XX7CX

3- TIN
5- NICKEL

1- 3u" 2- 6u"
3-15u" 4-30u"
5-50u" 6-Pd20u"
7-Pd30u" 8-Pd10u"

0-608-A06-1490

5 J-513-A05-0130

4 F-GOLD FLASH

5-0362-1

MM (INCH)	DFTO SYANG	DATE 12/30/'97	FULL RISE ELECTRONIC CO., LTD
TOLERANCES EXCEPT AS NOTED	CHKD QIANPU	DATE 2004/7/9	
MM .0 ±0.2 ± .00 ±0.15 ± .000 ±0.075 ±	MFO	DATE	TITLE 20.57 PCB JACK 8P
	APPVL CZH	DATE 2004/7/9	
ANGLES ± 0.5	MATERIAL :		DRAWING NO. GE593015 SIZE A3 REV 6
	QT'Y :		/PART NO. SEE NOTE
THIRD ANGLE PROJECTION	FINISH :		
DETACHED LISTS	SCALE : 2.5 : 1		DO NOT SCALE DRAWING SHEET OF